QOCVO

SiC JFET Division

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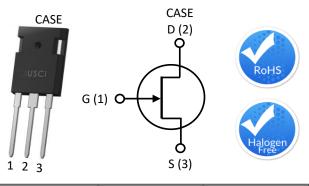


Silicon Carbide (SiC) JFET - EliteSiC, Power N-Channel, TO-247-3L, 650 V, 25 mohm UJ3N065025K3S

Datasheet

Description

United Silicon Carbide, Inc offers the high-performance G3 SiC normallyon JFET transistors. This series exhibits ultra-low on resistance ($R_{DS(ON)}$) and gate charge (Q_G) allowing for low conduction and switching loss. The device normally-on characteristics with low $R_{DS(ON)}$ at $V_{GS} = 0$ V is also ideal for current protection circuits without the need for active control, as well as for cascode operation.



Part Number	Package	Marking		
UJ3N065025K3S	TO-247-3L	UJ3N065025K3S		

Typical Applications

- Over current protection circuits
- DC-AC inverters
- Switch mode power supplies
- Power factor correction modules
- Motor drives
- Induction heating

Features

- Typical on-resistance $R_{DS(on),typ}$ of $25m\Omega$
- Voltage controlled
- Maximum operating temperature of 175°C
- Extremely fast switching not dependent on temperature
- Low gate charge
- Low intrinsic capacitance
- RoHS compliant
- AECQ Qualified

Maximum Ratings

Parameter	Symbol	Test Conditions	Value	Units	
Drain-source voltage	V _{DS}		650	V	
	V _{GS}	DC	-20 to +3		
Gate-source voltage		AC ⁽¹⁾	-20 to +20	V	
Continuous drain current ⁽²⁾	I _D	T _C = 25°C	85	А	
Continuous drain current *		T _c = 100°C	62	А	
Pulsed drain current ⁽³⁾	I _{DM}	T _C = 25°C	250	А	
Power dissipation	P _{tot}	T _C =25°C	441	W	
Maximum junction temperature	T _{J,max}		175	°C	
Operating and storage temperature	T _J , T _{STG}		-55 to 175	°C	
Max. lead temperature for soldering, 1/8" from case for 5 seconds	TL		250	°C	

(1) +20V AC rating applies for turn-on pulses <200ns applied with external $R_{G} > 1\Omega$.

(2) Limited by T_{J,max}

(3) Pulse width t_p limited by T_{J,max}



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Electrical Characteristics (T_J = +25°C unless otherwise specified)

Typical Performance - Static

Doromotor	Symbol	Test Conditions		Value		Units
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Drain-source breakdown voltage	BV _{DS}	V _{GS} = - 20V, I _D =1mA	650			V
Total drain leakage current		V _{DS} = 650V, V _{GS} = -20V, T _J = 25°C		10	60	- μΑ
	Ι _D	V _{DS} = 650V, V _{GS} = -20V, T _J = 175°C		40		
Total gate leakage current		V _{GS} =-20V, T _j =25°C		10	100	μΑ
	I _G	V _{GS} =-20V, T _j =175°C		38		μη
	R _{DS(on)}	V _{GS} =2V, I _D =20A, T _J = 25°C		22		- mΩ
Drain-source on-resistance		V _{GS} =0V, I _D =20A, T _J = 25°C		25	33	
		V _{GS} =2V, I _D =20A, T _J = 175°C		38		
		V _{GS} =0V, I _D =20A, T _J = 175°C		43		
Gate threshold voltage	V _{G(th)}	V _{DS} = 5V, I _D = 70mA	-14	-11.5	-6	V
Gate resistance	R _G	f = 1MHz, open drain		2.5		Ω



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Typical Performance - Dynamic

Parameter	symbol	Test Conditions	Value			Units	
Parameter	symbol		Min	Тур	Max	Onits	
Input capacitance	C _{iss}	V _{DS} = 100V,		2360			
Output capacitance	C _{oss}	V _{GS} = -20V,		290		pF	
Reverse transfer capacitance	C _{rss}	f = 100kHz		282			
Effective output capacitance, energy related	C _{oss(er)}	$V_{DS} = 0V \text{ to } 400V,$ $V_{GS} = -20V$		210		pF	
Total gate charge	Q _G			240			
Gate-drain charge	Q _{GD}	V_{DS} =400V, I_{D} = 60A,		134		nC	
Gate-source charge	Q _{GS}	V _{GS} =-18V to 0V		24			
Turn-on delay time	t _{d(on)}	V_{DS} =400V, I _D =60A, Gate Driver =-18V to 0V, $R_{G,EXT} = 1\Omega$, Inductive Load, FWD: UJ3D06530TS		11		- ns	
Rise time	t _r			64			
Turn-off delay time	t _{d(off)}			43			
Fall time	t _f			44			
Turn-on energy	E _{ON}			740			
Turn-off energy	E _{OFF}	T _J = 25°C		818		μ	
Total switching energy	E _{TOTAL}			1558			
Turn-on delay time	t _{d(on)}			11			
Rise time	t _r	$V_{DS}=400V, I_{D}=60A,$ Gate Driver =-18V to 0V, $R_{G,EXT} = 1\Omega,$ Inductive Load, FWD: UJ3D06530TS $T_{J} = =150^{\circ}C$		62		20	
Turn-off delay time	t _{d(off)}			38		ns	
Fall time	t _f			41		1	
Turn-on energy	E _{ON}			663			
Turn-off energy	E _{OFF}			750		μ	
Total switching energy	E _{TOTAL}			1413			

Thermal Characteristics

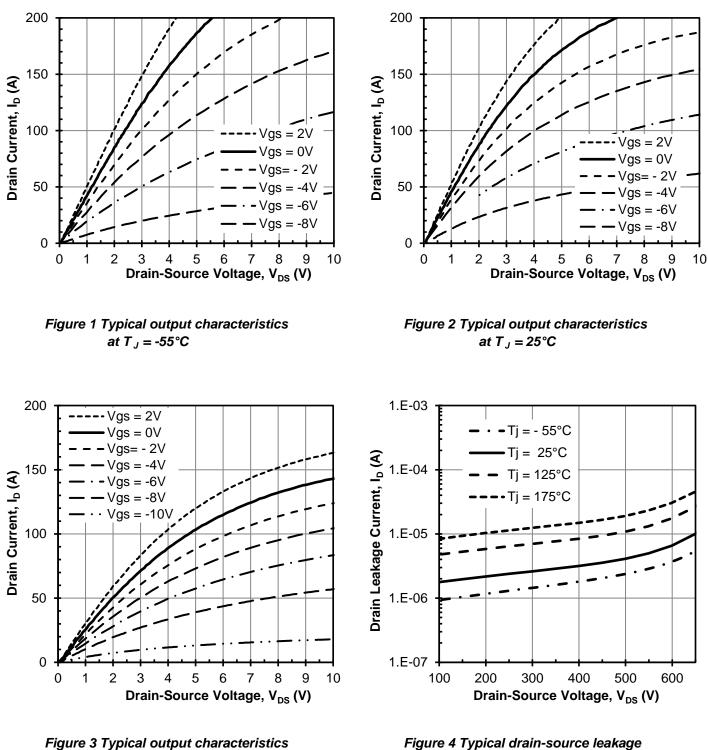
Parameter	symbol	Test Conditions	Value			Units
			Min	Тур	Max	Onits
Thermal resistance, junction-to-case	$R_{\theta JC}$			0.26	0.34	°C/W



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Typical Performance Diagrams



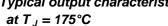
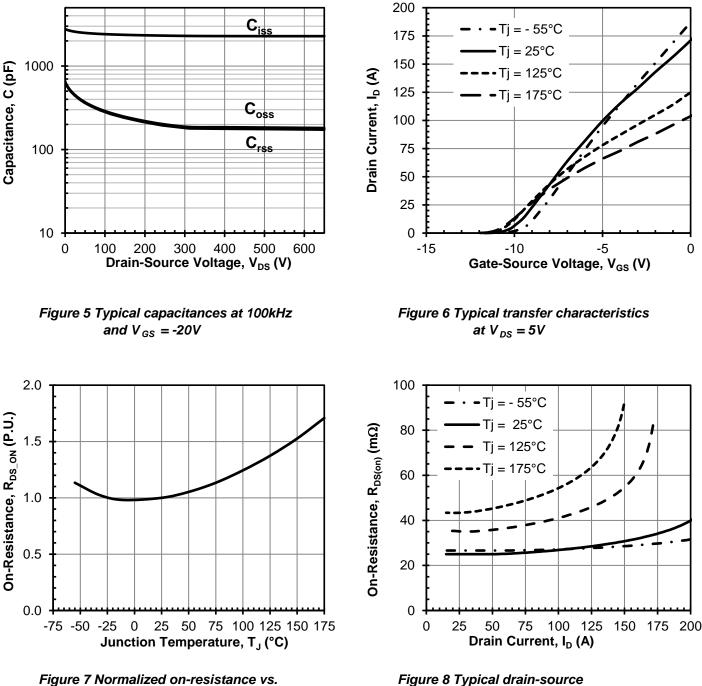
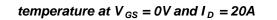


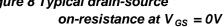
Figure 4 Typical drain-source leakage at $V_{GS} = -20V$



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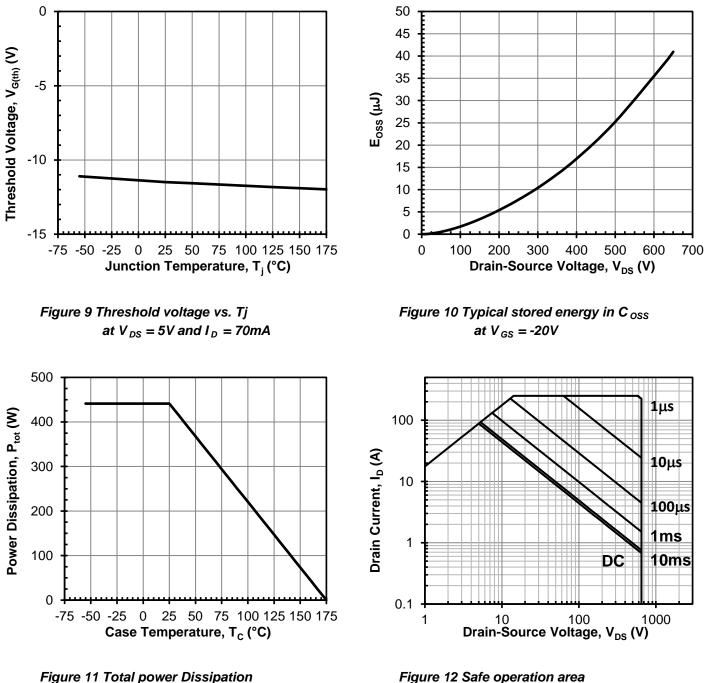
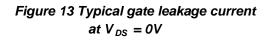


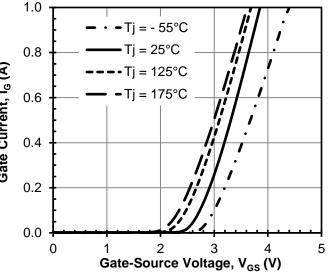
Figure 12 Safe operation area $T_c = 25^{\circ}C$, Parameter t_p

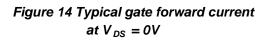


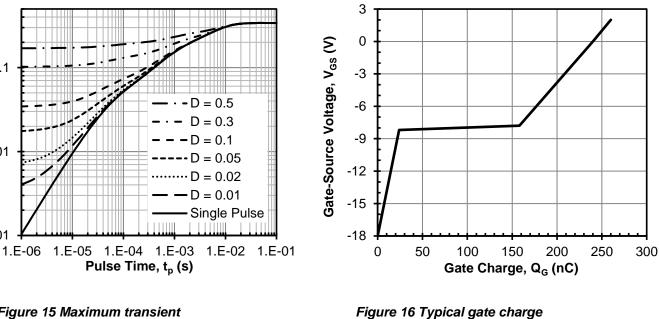
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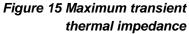
1.E-04 **–** Tj = - 55°C Tj = 25°C Tj = 125°C 1.E-05 Gate Current, I_G (A) Gate Current, I_G (A) Tj = 175°C 1.E-06 1.E-07 1.E-08 -20 -15 -10 -5 0 Gate-Source Voltage, V_{GS} (V)











0.01

Thermal Impedance, $Z_{\theta,JC}$ (°C/W)

0.1

0.001

at $V_{DS} = 400V$ and $I_D = 60A$



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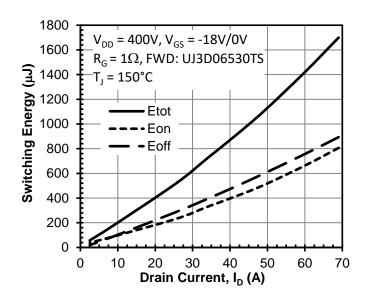
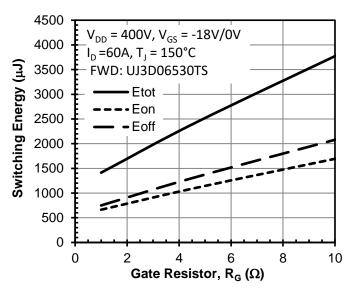
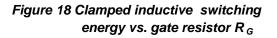


Figure 17 Clamped inductive switching energy vs. drain current at $T_J = 150^{\circ}$ C





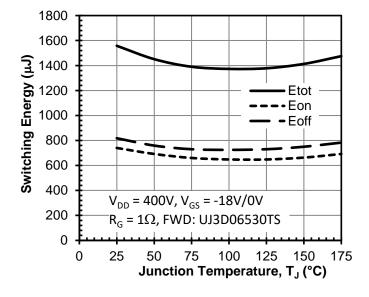


Figure 19 Clamped inductive switching energy vs. junction temperature at $I_D = 60A$



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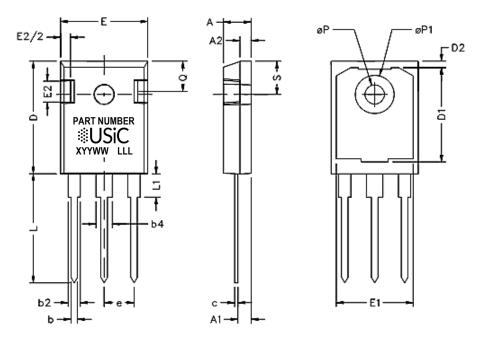
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TO-247-3L PACKAGE OUTLINE, PART MARKING AND TUBE SPECIFICATIONS

PACKAGE OUTLINE



SYM	INC	HES	MILLIMETERS		
	MIN	MAX	MIN	МАХ	
A	0.185	0.209	4.699	5.309	
A1	0.087	0.102	2.21	2.61	
A2	0.059	0.098	1.499	2.489	
b	0.039	0.055	0.991	1.397	
b2	0.065	0.094	1.651	2.388	
b4	0.102	0.135	2.591	3.429	
С	c 0.015 D 0.819 D1 0.515		0.381	0.889	
D			20.803	21.463	
D1			13.081	-	
D2	0.02	0.053	0.508	1.346	
E	0.61	0.64	15.494	16.256	
е	0.214	4 BSC	5.44 BSC		
E1	0.53	-	13.462	-	
E2	0.135	0.157	3.429	3.988	
L	0.78	0.8	19.812	20.32	
L1	-	0.177	-	4.496	
ØР	0.14	0.144	3.556	3.658	
ØP1	0.278	0.291	7.061	7.391	
Q	0.212	0.244	5.385	6.198	
S	0.243	3 BSC	6.17 BSC		



PART MARKING

PART NUMBER SUSSE XYYWW LLL

PART NUMBER = REFER TO DS_PN DECODER FOR DETAILS

X = ASSEMBLY SITE YY = YEAR WW = WORK WEEK LLL = LOT ID

PACKING TYPE

ANTI-STATIC TUBE

QUANTITY / TUBE : 30 UNITS

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